Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

Send any inquiries to http://www.renesas.com/inquiry.

Notice

- 1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
- Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
- 3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
- 4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
- 5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
- 6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
- 7. Renesas Electronics products are classified according to the following three quality grades: "Standard", "High Quality", and "Specific". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as "Specific" without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as "Specific" or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is "Standard" unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.
 - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anticrime systems; safety equipment; and medical equipment not specifically designed for life support.
 - "Specific": Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
- 8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
- 9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
- 10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
- 12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.
- (Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majorityowned subsidiaries.
- (Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.



User's Manual

IE-78K0-NS-PA

Performance Board

Target Devices 78K/0 Series

Document No. U16109EJ1V0UM00 (1st edition) Date Published June 2002 N CP(K)

© NEC Corporation 2002 Printed in Japan

V40 Family is a trademark of NEC Corporation.

Windows is either a registered trademark or a trademark of Microsoft Corporation in the United States and/or other countries.

PC/AT is a trademark of International Business Machines Corporation.

- The information in this document is current as of May, 2002. The information is subject to change
 without notice. For actual design-in, refer to the latest publications of NEC's data sheets or data
 books, etc., for the most up-to-date specifications of NEC semiconductor products. Not all products
 and/or types are available in every country. Please check with an NEC sales representative for
 availability and additional information.
- No part of this document may be copied or reproduced in any form or by any means without prior written consent of NEC. NEC assumes no responsibility for any errors that may appear in this document.
- NEC does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from the use of NEC semiconductor products listed in this document or any other liability arising from the use of such products. No license, express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC or others.
- Descriptions of circuits, software and other related information in this document are provided for illustrative purposes in semiconductor product operation and application examples. The incorporation of these circuits, software and information in the design of customer's equipment shall be done under the full responsibility of customer. NEC assumes no responsibility for any losses incurred by customers or third parties arising from the use of these circuits, software and information.
- While NEC endeavours to enhance the quality, reliability and safety of NEC semiconductor products, customers
 agree and acknowledge that the possibility of defects thereof cannot be eliminated entirely. To minimize
 risks of damage to property or injury (including death) to persons arising from defects in NEC
 semiconductor products, customers must incorporate sufficient safety measures in their design, such as
 redundancy, fire-containment, and anti-failure features.
- NEC semiconductor products are classified into the following three quality grades:
 "Standard", "Special" and "Specific". The "Specific" quality grade applies only to semiconductor products
 developed based on a customer-designated "quality assurance program" for a specific application. The
 recommended applications of a semiconductor product depend on its quality grade, as indicated below.
 Customers must check the quality grade of each semiconductor product before using it in a particular
 application.
 - "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
 - "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC semiconductor products is "Standard" unless otherwise expressly specified in NEC's data sheets or data books, etc. If customers wish to use NEC semiconductor products in applications not intended by NEC, they must contact an NEC sales representative in advance to determine NEC's willingness to support a given application.

(Note)

- (1) "NEC" as used in this statement means NEC Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC semiconductor products" means any semiconductor product developed or manufactured by or for NEC (as defined above).

Regional Information

Some information contained in this document may vary from country to country. Before using any NEC product in your application, please contact the NEC office in your country to obtain a list of authorized representatives and distributors. They will verify:

- · Device availability
- Ordering information
- Product release schedule
- · Availability of related technical literature
- Development environment specifications (for example, specifications for third-party tools and components, host computers, power plugs, AC supply voltages, and so forth)
- Network requirements

In addition, trademarks, registered trademarks, export restrictions, and other legal issues may also vary from country to country.

NEC Electronics Inc. (U.S.)

Santa Clara, California Tel: 408-588-6000 800-366-9782 Fax: 408-588-6130 800-729-9288

NEC do Brasil S.A.

Electron Devices Division Guarulhos-SP, Brasil Tel: 11-6462-6810 Fax: 11-6462-6829

NEC Electronics (Europe) GmbH

Duesseldorf, Germany Tel: 0211-65 03 01 Fax: 0211-65 03 327

- Sucursal en España Madrid, Spain Tel: 091-504 27 87 Fax: 091-504 28 60
- Succursale Française Vélizy-Villacoublay, France Tel: 01-30-67 58 00 Fax: 01-30-67 58 99

- Filiale Italiana Milano, Italy Tel: 02-66 75 41 Fax: 02-66 75 42 99
- Branch The Netherlands Eindhoven, The Netherlands Tel: 040-244 58 45 Fax: 040-244 45 80
- Branch Sweden Taeby, Sweden Tel: 08-63 80 820 Fax: 08-63 80 388
- United Kingdom Branch Milton Keynes, UK Tel: 01908-691-133 Fax: 01908-670-290

NEC Electronics Hong Kong Ltd. Hong Kong Tel: 2886-9318 Fax: 2886-9022/9044

NEC Electronics Hong Kong Ltd. Seoul Branch Seoul, Korea Tel: 02-528-0303 Fax: 02-528-4411

NEC Electronics Shanghai, Ltd. Shanghai, P.R. China Tel: 021-6841-1138

Fax: 021-6841-1137

NEC Electronics Taiwan Ltd. Taipei, Taiwan

Tel: 02-2719-2377 Fax: 02-2719-5951

NEC Electronics Singapore Pte. Ltd. Novena Square, Singapore Tel: 253-8311 Fax: 250-3583

INTRODUCTION

 Product overview
 The IE-78K0-NS-PA is used in combination with an in-circuit emulator (IE-78K0-NS), emulation board (IE-780×××-NS-EM1, IE-780×××-NS-EM4), and I/O board (IE-78K0-NS-PO×) to debug products of the 78K/0 Series of 8-bit single-chip microcontrollers.

 Target readers
 This manual is intended for engineers who perform debugging of systems that employ

 the 78K/0 Series of 8-bit single-chip microcontrollers using the IE-78K0-NS-PA and an

 in-circuit emulator (IE-78K0-NS), emulation board (IE-780×××-NS-EM1, IE-780×××-NS-EM4), and I/O board (IE-78K0-NS-P0×) together.

- Purpose
 The purpose of this manual is to help the user understand the debugging functions that are available by using the IE-78K0-NS-PA and the in-circuit emulator (IE-78K0-NS), emulation board (IE-780×××-NS-EM1, IE-780×××-NS-EM4), and I/O board (IE-78K0-NS-P0×) together.
- Organization When using the IE-78K0-NS-PA, please refer to the manual (this manual) that comes with the IE-78K0-NS-PA as well as the manual that comes with the in-circuit emulator (IE-78K0-NS), emulation board (IE-780×××-NS-EM1, IE-780×××-NS-EM4), and I/O board (IE-78K0-NS-P0×).

IE-78K0-NS	
User's Manual	

- General
- Part names
- Installation
- External interface

IE-78K0-NS-P0× User's Manual

- General
- Part names
- Installation

IE-78K0-NS-PA User's Manual (This manual)

- General
- Part names
- Installation
- External sense specifications
- Cautions



- General
- Part names
- Installation
- Differences between target devices and target interface circuits

How to read this manual To understand the overall functions of the IE-78K0-NS-PA:

 \rightarrow Read this manual in the order of the contents.

To understand the basic specifications: \rightarrow Refer to CHAPTER 1 GENERAL and CHAPTER 2 PART NAMES.

For how to connect the IE-78K0-NS, IE-780×××-NS-EM1, IE-780×××-NS-EM4, and IE-78K0-NS-P0× and make settings to debug 78K/0 Series products: \rightarrow Refer to **CHAPTER 3 INSTALLATION**.

Terminology The meanings of the terms used in this manual are described in the table below.

Term	Meaning
Target device	This is the device to be emulated.
Target system	This is the system to be debugged. This includes the target program and the hardware provided by the user. When defined narrowly, it includes only the hardware.
IE system	This refers to the combination of an in-circuit emulator (IE-78K0-NS), emulation board (IE-780×××-NS-EM×), and I/O board (IE-78K0-NS-P0×).

 Conventions
 Data significance:
 Higher digits on the left and lower digits on the right

 Note:
 Footnote for item marked with Note in the text

 Caution:
 Information requiring particular attention

 Remark:
 Supplementary information

Related documents The related documents (user's manuals) indicated in this publication may include preliminary versions. However, preliminary versions are not marked as such.

Document Name	Document No.		
IE-78K0-NS In-Circuit Emulator	U13731E		
IE-78K0-NS-PA Performance Board	This manual		
ID78K Series Integrated Debugger Ver. 2.30 or Later Operation (Windows [™] Based)	U15185E		

Caution The related documents listed above are subject to change without notice. Be sure to use the latest version of each document for designing.

CONTENTS

CHAPTER 1 GENERAL	11
1.1 System Configuration	11
1.2 Hardware Configuration	13
1.3 Basic Specifications	14
CHAPTER 2 PART NAMES	16
2.1 Parts of Main Unit	17
2.2 External Sense Probe Names	18
CHAPTER 3 INSTALLATION	19
CHAPTER 4 EXTERNAL SENSE SPECIFICATIONS	26
CHAPTER 5 CAUTIONS	27

LIST OF FIGURES

Figur	igure No. Title		Page
1-1	IE-78K0-NS-PA System Configuration		
1-2	Basic Hardware Configuration		13
2-1	Performance Board		17
3-1	Connecting Emulation Board (IE-780×××-NS-EM1)		20
3-2	Connecting I/O Board (IE-78K0-NS-P0×) and Emula	ation Board (IE-780×××-NS-EM4)	
3-3	Connecting External Sense Probe		24
3-4	Connecting Emulation Probe		25

LIST OF TABLES

Tabl	le No. Title	Page
1-1	List of Functions (MAX. Specifications)	14
2-1	Correspondence Between Connector No. and Color of Cable	
2-2	Bit Configuration When Connecting External Sense Probe to EXTCN1	
2-3	Bit Configuration When Connecting External Sense Probe to EXTCN2	
4-1	Electrical Specifications of External Sense	

CHAPTER 1 GENERAL

The IE-78K0-NS-PA is a development tool for effectively debugging hardware and software in which a 78K/0 Series 8-bit single-chip microcontroller is used as the target device.

This chapter describes the system configuration and basic specifications of the IE-78K0-NS-PA.

1.1 System Configuration

Figure 1-1 shows the system configuration of the IE-78K0-NS-PA.



Figure 1-1. IE-78K0-NS-PA System Configuration

Note For the device file, emulation probe, and conversion socket/conversion adapter, refer to the IE-780×××-NS-EM1 or IE-780×××-NS-EM4 User's Manual.

1.2 Hardware Configuration

The position of the IE-78K0-NS-PA is shown in Figure 1-2.



Figure 1-2. Basic Hardware Configuration

1.3 Basic Specifications

Pa	rameter	IE-78K0-NS Single Unit Functions	Functions Added by Combining IE-78K0-NS with IE-78K0-NS-PA					
Supervisor		V40 [™] (operating frequency: 16.0 MHz)						
Target device		78K/0 Series (μPD780×××)						
System clock		According to specification of emulation board	d (sold separately)					
Clock supply	External	Pulse input						
	Internal	Mounted on emulation board (sold separately)						
Substitute memo	bry capacity	64 KB						
Mapping unit	Internal ROM	4 КВ						
	Internal high-speed RAM	64 bytes						
	Internal low-speed RAM	128 bytes						
	External expansion memory	8 KB						
Emulation function	วท	Real-time execution Break execution Step execution						
Real-time internal RAM monitor		2 KB of entire data memory space						
Event detection		 Program execution detection: 2 (fetch) (BRS1, BRS2) Bus event detection: 4 (access) (BRA1 to BRA4) Program execution detection: 8 (fetch) (BRS3 to BRS10) Bus event detection: 8 (access) (BRA5 to BRA12) 						
Event integration	1	 Trigger condition Path condition Delay condition Trace qualify condition 						
Break factors		 External trigger detection (EXTIN: 1) Trigger output OUT (open-drain output: 1) Event break Manual break Command break Fail-safe break 						
Real-time trace Trace factors		All tracesQualify trace (access only)	 Section trace (both fetch and access) (inter-event trace)^{Note} 					
	Trace capacity	32 bits \times 8 KB	48 bits \times 8 KB					
	Trace contents	 Address Data Status 	 External sense traces: 16 (8 of which (EXTCN1) can be used as external single event inputs) Time stamp Snap shot 					

Table 1-1. List of Functions (MAX. Specifications) (1/2)

Note Events use BRS3 to BRS10 and BRA5 to BRA12 added by the IE-78K0-NS-PA.

Parameter	IE-78K0-NS Single Unit Functions	Functions Added by Combining IE-78K0-NS with IE-78K0-NS-PA
Execution time measurement	Up to 4 min 28 s, resolution: 62.5 ns	
Inter-event time measurement	_	 Resolution: Changeable between 160 ns and 20.56 µs Maximum measurement time When resolution is set to 160 ns: Approximately 11 minutes When resolution is set to 20.56 µs: Approximately 24 hours^{Note}
Coverage	_	64 KB space (read, write, fetch)
DMM	_	16 events ^{Note}
Target interface	Emulation probe (sold separately) provided f	or each target device shape
Host interface	Dedicated bus interface	
Low-voltage support	According to specification of emulation board	d (sold separately)
Host machine	PC-9800 series, or IBM PC/AT and compatil	bles
Power supply	DC 5 V	
Dimensions	W240 × D197 × H73 (mm)	

Table 1-1. List of Functions (MAX. Specifications) (2/2)

Note Events use BRS3 to BRS10 and BRA5 to BRA12 added by the IE-78K0-NS-PA.

CHAPTER 2 PART NAMES

This chapter introduces the parts of the IE-78K0-NS-PA main unit.

The packing box contains the performance board, 2 external sense probes, 20 external sense clips, a packing list, the user's manual, and a guarantee card.

If there are any missing or damaged items, please contact an NEC sales representative.

Please make sure to fill out and return the guarantee card that comes with the main unit.

2.1 Parts of Main Unit







< Soldering side >



2.2 External Sense Probe Names

The IE-78K0-NS-PA includes external sense probes and external sense clips.

(1) External sense probes: 2



 Table 2-1. Correspondence Between Connector No. and Color of Cable

Connector No.	1	2	3	4	5	6	7	8	9	10
Color of cable	Brown	Red	Orange	Yellow	Green	Blue	Purple	Gray	N.C.	Black

The names of the external sense probes when they are connected to EXTCN1 and EXTCN2 are as follows.

Table 2-2.	Bit Configuration	When Connecting	External Sense	Probe to EXTCN1
------------	--------------------------	-----------------	----------------	------------------------

Connector No.	1	2	3	4	5	6	7	8	9	10
External sense	EXT1	EXT2	EXT3	EXT4	EXT5	EXT6	EXT7	EXT8	N.C.	GND

Table 2-3. Bit Configuration When Connecting External Sense Probe to EXTCN2

Connector No.	1	2	3	4	5	6	7	8	9	10
External sense	EXT9	EXT10	EXT11	EXT12	EXT13	EXT14	EXT15	EXT16	N.C.	GND

Remark N.C.: No connection

- (2) External sense clips: 20 (16 for external sense probes, 2 for GND, and 2 spares)
 - Made by Sunhayato Corporation (2 sets of 10)



CHAPTER 3 INSTALLATION

This chapter describes how to connect the IE-78K0-NS-PA to the IE-78K0-NS, emulation board, etc.

Caution Connecting and removing cables or components from the target system and changing the settings of switches, etc. should be carried out after turning off the power supply of the IE system and the target system.

(1) Connecting emulation board (IE-780xxx-NS-EM1)

The IE-780×××-NS-EM1 is sold separately.

Figure 3-1. Connecting Emulation Board (IE-780xxx-NS-EM1) (1/2)

<1> Remove the screws from the sides of the main unit, and then remove the top cover.



<3> Connect the IE-78K0-NS-PA and fix the spacers (metal) included with this product at five points on the board.



<2> Remove the first and second plates from the bottom by removing the screws.



Caution Only when connecting the IE-78018-NS-EM1 on the IE-78K0-NS-PA, remove spacer 1 (metal) of the following figure and replace spacers 2 and 3 (metal) with spacers (plastic) included with this product.



<4> Connect the IE-780×××-NS-EM1 to the IE-78K0-NS-PA and fasten the two screws.



IE-78K0-NS-PA

<5> When using an emulation probe, connect the corresponding emulation probe.





Refer to (3) for the external sense probe connection method.



<6> Replace the top cover and fasten the four screws on the sides.



(2) Connecting I/O board (IE-78K0-NS-P0x) and emulation board (IE-780xxx-NS-EM4)

The IE-78K0-NS-P0× and IE-780×××-NS-EM4 are sold separately.

Figure 3-2. Connecting I/O Board (IE-78K0-NS-P0×) and Emulation Board (IE-780×××-NS-EM4) (1/2)

<1> Remove the screws from the sides of the main unit, and then remove the top cover.



<3> Connect the IE-78K0-NS-PA and fix the spacers (metal) included with this product at five points on the board.



<5> Connect the IE-780xxx-NS-EM4 on the IE-78K0-NS-P0x, and fasten the screws at the four corners.



<2> Remove the first and third plates from the bottom by removing the screws.



<4> Connect the IE-78K0-NS-P0× on the IE-78K0-NS-PA and fix the spacers included with the IE-78K0-NS-P0× at the four corners.



<6> When using an emulation probe, connect the corresponding emulation probe.



Refer to (3) for the external sense probe connection method.

Figure 3-2. Connecting I/O Board (IE-78K0-NS-P0×) and Emulation Board (IE-780××+NS-EM4) (2/2)

<7> Replace the top cover and fasten the four screws on the sides.



(3) Connecting external sense probe



Figure 3-3. Connecting External Sense Probe

(4) Connecting emulation probe (NP-xxxx)

NP-xxxx is sold separately.



Figure 3-4. Connecting Emulation Probe

Caution The emulation probe (NP-xxxx) mounting location varies depending on the emulation board in use. For details, refer to the user's manual of the corresponding emulation board.

CHAPTER 4 EXTERNAL SENSE SPECIFICATIONS

Up to 16-bit data can be input to the IE-78K0-NS-PA from the target system via an external sense probe. Also, when using an external event input, input a level of at least 2 CPU clocks.

Table 4-1. Electrical Specifications of External Sense

Parameter	MIN. [V]	MAX. [V]	
Input voltage, high	Target voltage ^{Note} \times 0.7	Target voltage ^{Note}	
Input voltage, low	0	Target voltage ^{Note} \times 0.3	

Note 2.0 V when the target voltage is less than 2.0 V.

CHAPTER 5 CAUTIONS

- (1) When debugging is performed by connecting the performance board IE-78K0-NS-PA to the in-circuit emulator IE-78K0-NS and the corresponding emulation board, use an in-circuit emulator or an integrated debugger that satisfies the following conditions.
 - Use an in-circuit emulator IE-78K0-NS with control code D or later.
 - Use version 2.00 or later of the integrated debugger ID78K0-NS.
- (2) If it is set that DMM or snap shot occurs during the measurement section of the execution time, the execution time measurement value becomes larger than the actual value.
 - O Countermeasure: Do not specify DMM or snap shot during the measurement section of the execution time.
- (3) When section trace is specified and then DMM or snap shot is specified, the trace data may not appear correctly.
 - O Countermeasure: Do not set a DMM or snap shot event when performing a section trace. Do not set a section trace when performing a DMM or snap shot event.

NEC

Facsimile Message

Although NEC has taken all possible steps to ensure that the documentation supplied to our customers is complete, bug free and up-to-date, we readily accept that errors may occur. Despite all the care and precautions we've taken, you may encounter problems in the documentation. Please complete this form whenever you'd like to report errors or suggest improvements to us.

FAX

Address

Tel.

From:

Name

Company

Thank you for your kind support.

North America NEC Electronics Inc. Corporate Communications Dept. Fax: +1-800-729-9288 +1-408-588-6130	Hong Kong, Philippines, Oceania NEC Electronics Hong Kong Ltd. Fax: +852-2886-9022/9044	Taiwan NEC Electronics Taiwan Ltd. Fax: +886-2-2719-5951
Europe NEC Electronics (Europe) GmbH Market Communication Dept. Fax: +49-211-6503-274	Korea NEC Electronics Hong Kong Ltd. Seoul Branch Fax: +82-2-528-4411	Asian Nations except Philippines NEC Electronics Singapore Pte. Ltd. Fax: +65-250-3583
South America NEC do Brasil S.A. Fax: +55-11-6462-6829	P.R. China NEC Electronics Shanghai, Ltd. Fax: +86-21-6841-1137	Japan NEC Semiconductor Technical Hotline Fax: +81- 44-435-9608

I would like to report the following error/make the following suggestion:

Document title: ____

Document number: ____

_____ Page number: _____

If possible, please fax the referenced page or drawing.

Document Rating	Excellent	Good	Acceptable	Poor
Clarity				
Technical Accuracy				
Organization				